Semiconductor devices — Micro-electromechanical devices

Part 14: Forming limit measuring method of metallic film materials
This British Standard is the UK implementation of EN 62047-14:2012. It is identical to IEC 62047-14:2012.

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A list of organizations represented on this committee can be obtained on request to its secretary.

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<tr>
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</table>
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Part 14: Forming limit measuring method of metallic film materials
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Foreword


The following dates are fixed:

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Annex ZA
(normative)

Normative references to international publications
with their corresponding European publications

The following documents, in whole or in part, are normatively referenced in this document and are indispensable for its application. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

NOTE When an international publication has been modified by common modifications, indicated by (mod), the relevant EN/HD applies.

<table>
<thead>
<tr>
<th>Publication</th>
<th>Year</th>
<th>Title</th>
<th>EN/HD</th>
<th>Year</th>
</tr>
</thead>
</table>
CONTENTS

1 Scope ............................................................................................................................5
2 Normative references ...............................................................................................5
3 Terms, definitions and symbols ................................................................................5
   3.1 Terms and definitions ..............................................................................................5
   3.2 Symbols ..................................................................................................................6
4 Testing method .............................................................................................................6
   4.1 General ...................................................................................................................6
   4.2 Equipment ...............................................................................................................6
   4.3 Specimen ................................................................................................................7
5 Test procedure and analysis .......................................................................................8
   5.1 Test procedure .......................................................................................................8
   5.2 Data analysis ..........................................................................................................9
6 Test report ....................................................................................................................10
Annex A (informative) Principles of the forming limit diagram ...................................11
Annex B (informative) Grid marking method .................................................................13
Annex C (informative) Gripping method .......................................................................15
Annex D (informative) Strain measuring method ........................................................17

Figure 1 – Equipment and tools for forming limit tests .................................................7
Figure 2 – Rectangular specimens with six kinds of aspect ratio .......................................8
Figure 3 – Strain for forming limit measurement ...............................................................9
Figure 4 – Construct the forming limit diagram by plotting the major and minor strains ....9
Figure A.1 – Forming limit diagram ...............................................................................11
Figure A.2 – Hemispherical punch for forming limit measurement .................................11
Figure A.3 – Grid for forming limit measurement ............................................................12
Figure A.4 – Loading path of the specimen with various aspect ratios ............................12
Figure B.1 – Procedure of a photographic grid marking method .......................................13
Figure B.2 – Procedure for an inkjet grid marking method ...............................................14
Figure C.1 – Gripping of the specimen using a ring shaped die .......................................15
Figure C.2 – Gripping of the specimen using adhesive bonding .......................................16
Figure D.1 – Set up for strain measurement using digital camera ....................................17
Figure D.2 – Example of pixel converting image of deformed specimen ..........................17

Table 1 – List of letter symbols ......................................................................................6